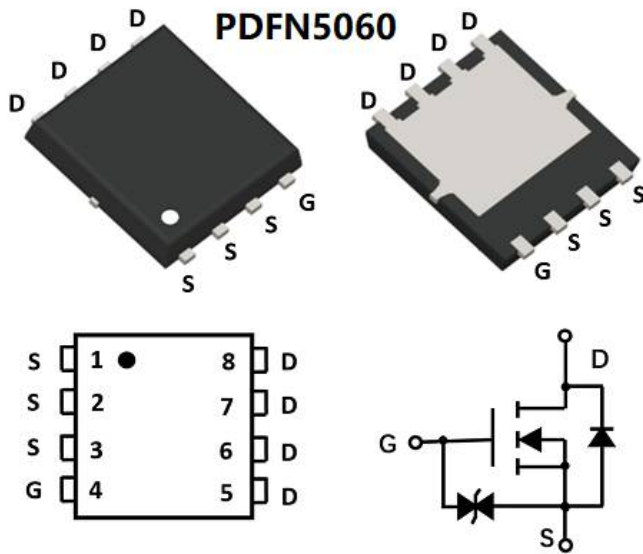


## N-Channel Enhancement Mode Field Effect Transistor



### Product Summary

- $V_{DS}$  60V
- $I_D$  85A
- $R_{DS(ON)}$ ( at  $V_{GS}=10V$ ) < 3.7 mohm
- $R_{DS(ON)}$ ( at  $V_{GS}=4.5V$ ) < 5.0 mohm
- 100% UIS Tested
- 100%  $\nabla V_{DS}$  Tested
- ESD Protected up to 2.0KV(HBM)

### General Description

- Split Gate Trench MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low  $R_{DS(ON)}$

### Applications

- DC-DC Converters
- Power management functions
- Synchronous-rectification application

### ■ Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		$V_{DS}$	60	V
Gate-source Voltage		$V_{GS}$	$\pm 20$	V
Drain Current <sup>A</sup>	$T_C=25^\circ\text{C}$	$I_D$	85	A
	$T_C=100^\circ\text{C}$		54	
Pulsed Drain Current <sup>B</sup>		$I_{DM}$	340	A
Avalanche energy		$E_{AS}$	400	mJ
Total Power Dissipation <sup>C</sup>	$T_C=25^\circ\text{C}$	$P_D$	110	W
	$T_C=100^\circ\text{C}$		44	
Junction and Storage Temperature Range		$T_J, T_{STG}$	-55~+150	$^\circ\text{C}$

### ■ Thermal resistance

Parameter		Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient <sup>D</sup>	$t \leq 10\text{S}$	$R_{\theta JA}$	14	17	$^\circ\text{C/W}$
Thermal Resistance Junction-to-Ambient <sup>D</sup>	Steady-State		40	55	
Thermal Resistance Junction-to-Case	Steady-State	$R_{\theta JC}$	0.85	1.1	

### ■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJG85G06AK	F1	YJG85G06AK	5000	10000	100000	13" reel



# YJG85G06AK

## ■ Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
<b>Static Parameter</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> =250μA	60			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V			1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> =0V			±10	μA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =250μA	1.0	1.6	2.5	V
Static Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> =20A		2.9	3.7	mΩ
		V <sub>GS</sub> = 4.5V, I <sub>D</sub> =20A		3.8	5.0	
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =20A, V <sub>GS</sub> =0V		0.8	1.3	V
Maximum Body-Diode Continuous Current	I <sub>S</sub>				85	A
Gate resistance	R <sub>g</sub>	f=1MHz, open drain		2		Ω
<b>Dynamic Parameters</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V, f=1MHz		4650		pF
Output Capacitance	C <sub>oss</sub>			850		
Reverse Transfer Capacitance	C <sub>rss</sub>			65		
<b>Switching Parameters</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>GS</sub> =10V, V <sub>DS</sub> =30V, I <sub>D</sub> =25A		70.78		nC
Gate-Source Charge	Q <sub>gs</sub>			16.64		
Gate-Drain Charge	Q <sub>gd</sub>			10.62		
Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> =20A, di/dt=500A/us		39.8		ns
Reverse Recovery Time	t <sub>rr</sub>			41.6		
Turn-on Delay Time	t <sub>D(on)</sub>	V <sub>GS</sub> =10V, V <sub>DD</sub> =30V, I <sub>D</sub> =25A R <sub>GEN</sub> =2Ω		15.9		ns
Turn-on Rise Time	t <sub>r</sub>			55.2		
Turn-off Delay Time	t <sub>D(off)</sub>			57.5		
Turn-off fall Time	t <sub>f</sub>			91.3		

A. Repetitive rating; pulse width limited by max. junction temperature.

B. V<sub>DD</sub>=50V, V<sub>GS</sub>=10V, L=2mH, I<sub>AS</sub>=20A.

C. Pd is based on max. junction temperature, using junction-case thermal resistance.

D. The value of R<sub>qJA</sub> is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub> =25°C. The Power dissipation PDSM is based on R<sub>qJA</sub> ≤ 10s and the maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.



## ■ Typical Performance Characteristics

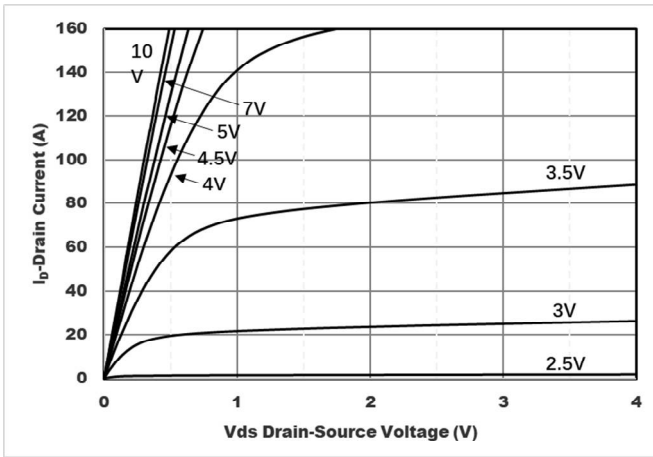


Figure1. Output Characteristics

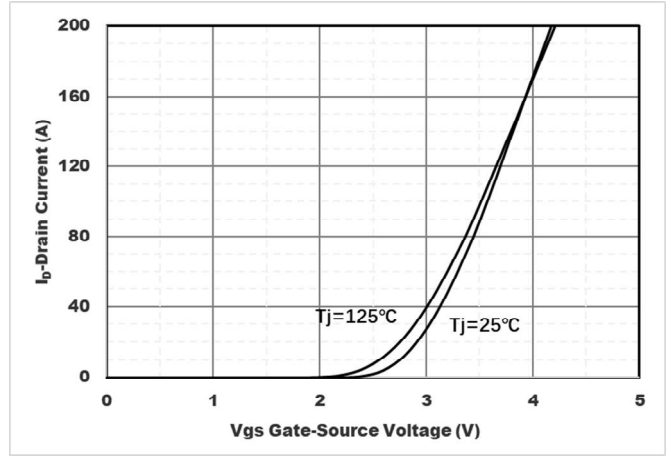


Figure2. Transfer Characteristics

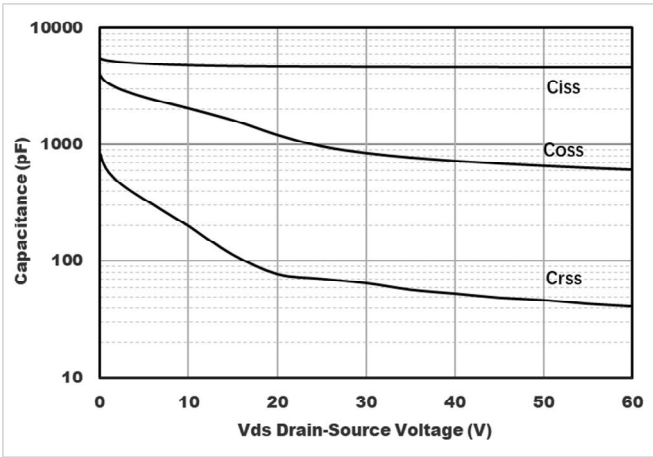


Figure3. Capacitance Characteristics

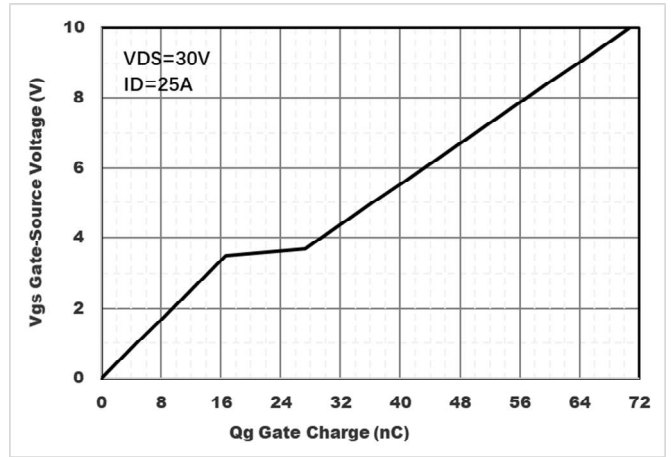


Figure4. Gate Charge

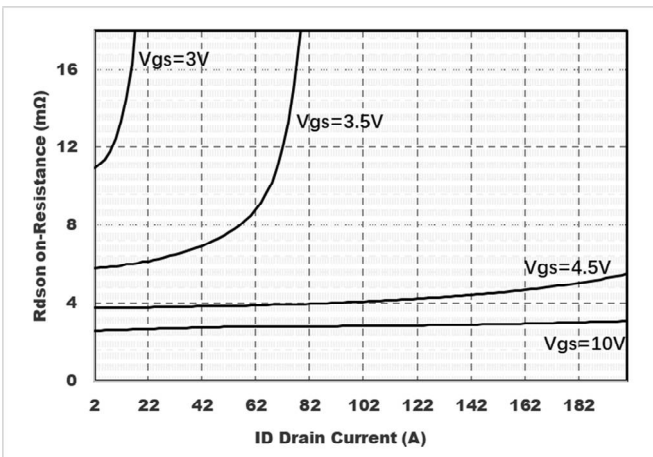


Figure5. Drain-Source on Resistance

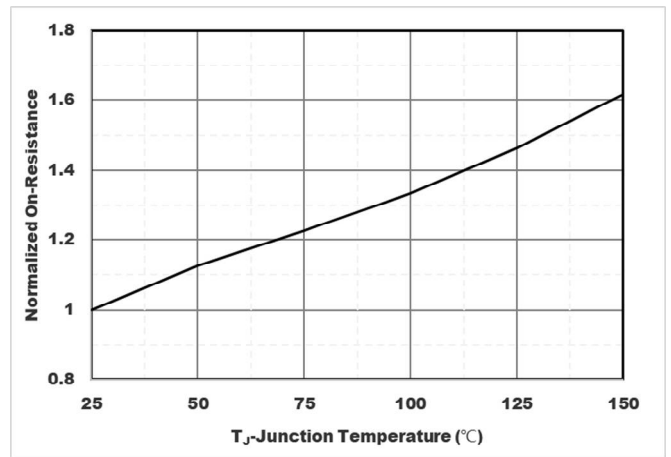


Figure6. Drain-Source on Resistance



# YJG85G06AK

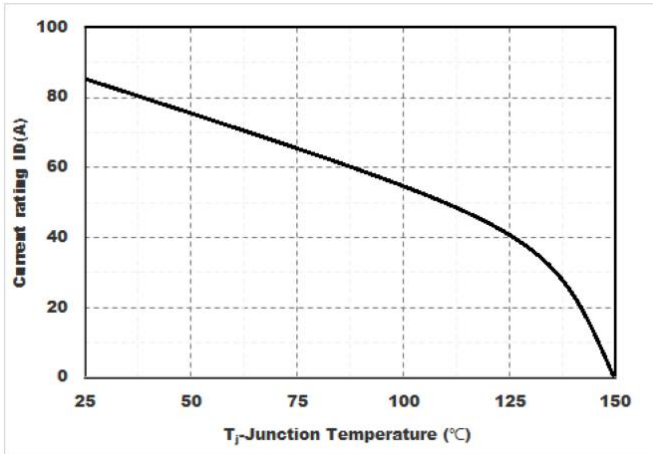


Figure7. Drain current

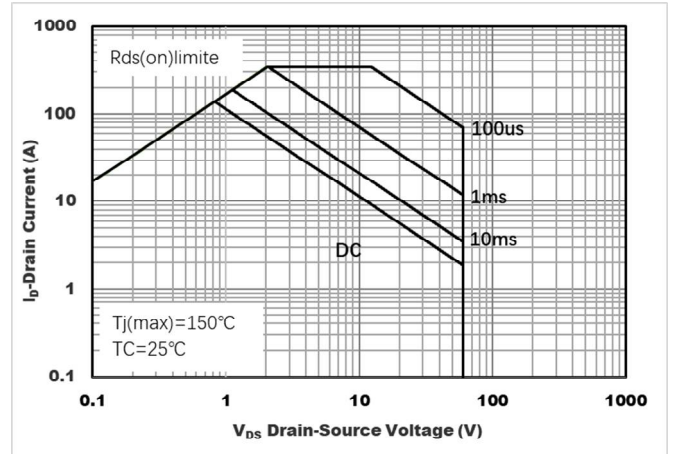


Figure8. Safe Operation Area

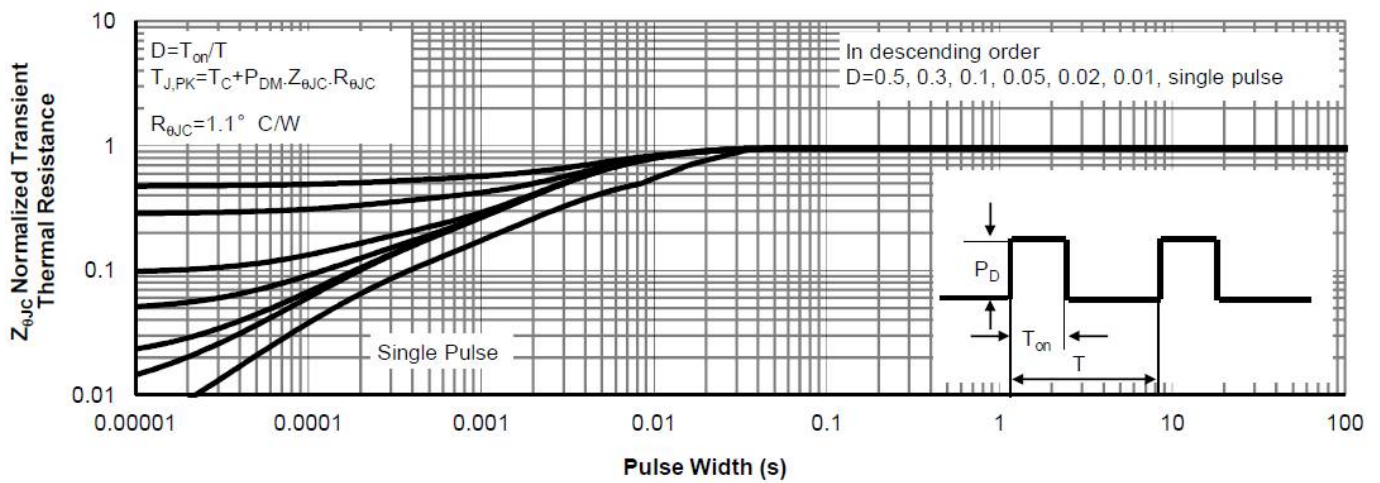
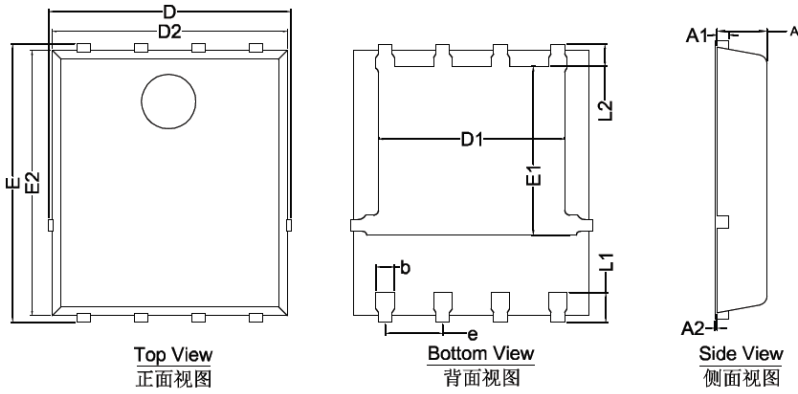


Figure9. Normalized Maximum Transient Thermal Impedance

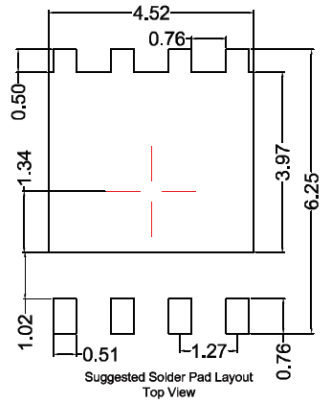


# YJG85G06AK

## ■ PDFN5060-8L Package information



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
D	5.15	5.35	5.55
E	5.95	6.15	6.35
A	1.00	1.10	1.20
A1	0.254 BSC		
A2			0.10
D1	3.92	4.12	4.32
E1	3.52	3.72	3.92
D2	5.00	5.20	5.40
E2	5.66	5.86	6.06
L1	0.56	0.66	0.76
L2	0.50 BSC		
b	0.31	0.41	0.51
e	1.27 BSC		



- Note:
1. Controlling dimension: in millimeters.
  2. General tolerance:  $\pm 0.10\text{mm}$ .
  3. The pad layout is for reference purposes only.



## YJG85G06AK

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[C3M0021120D](#)